Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	24	(("5611481") or ("3276750") or ("10321671") or ("0766310") or ("2159047") or ("0098046") or ("9213702") or ("9326465") or ("2000243785")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/20 12:45
S2	2	("20040169286").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/20 12:53
S3	1898	(257/737).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/20 12:54
S4	25	("5007163" | "5391514").PN. OR ("5611481").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:21
S5	12	"liquid phase diffusion" and sn and alloy	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:22
S6	221	"liquid phase diffusion"	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:31
S7	5626	diffusion adj bond$3	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:31
S8	437	diffusion adj bond$3 and sn	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:35
S9	768	diffusion adj bond$3 and eutectic	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:35
S10	222	diffusion adj bond$3 with eutectic	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:35

S11	52	(US-20010009297-$ or US-20010013655-$ or US-20010055146-$ or US-20020050404-$ or US-20020132463-$ or US-20030022479-$ or US-20030150635-$ or US-20030173665-$ or US-20030230806-$ or US-20040004292-$ or US-20040113272-$ or US-20040169277-$ or US-20040169286-$ or US-20040178503-$ or US-20050011937-$ or US-20050093149-$ or US-20050104208-$).did. or (US-4764804-$ or US-5421507-$ or US-5461261-$ or US-5611481-$ or US-5641990-$ or US-5666008-$ or US-5672913-$ or US-5734199-$ or US-5773897-$ or US-5796591-$ or US-5889326-$ or US-5930598-$ or US-6002172-$ or US-6011313-$ or US-6027957-$ or US-6088236-$ or US-6130476-$ or US-6153940-$ or US-6190940-$ or US-6198169-$ or US-6249051-$ or US-6281581-$ or US-6333554-$ or US-6369451-$ or US-6433425-$ or US-6492197-$). did. or (US-6507118-$ or US-6740823-$ or US-6858111-$ or US-6894389-$).did. or (JP-10321671-$ or JP-2000243785-$).did. or (JP-08031835-$ or JP-10321671-$ or JP-2000243785-$).did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/11/16 14:13
S12	77	bump with (align or alignment or self-align) and (resin with underfill)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/16 14:21
S13	1092	"flip chip" and self-align$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/16 14:23
S14	375	"flip chip" and self-align$4 with (bump or ball or electrode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/16 14:24